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### Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

### Applications of Embedded - CPLDs

#### Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	5 ns
Voltage Supply - Internal	1.65V ~ 1.95V
Number of Logic Elements/Blocks	16
Number of Macrocells	256
Number of Gates	-
Number of I/O	128
Operating Temperature	-40°C ~ 105°C (TJ)
Mounting Type	Surface Mount
Package / Case	176-LQFP
Supplier Device Package	176-TQFP (24x24)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4256c-5t176i">https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4256c-5t176i</a>

- Block CLK2
- Block CLK3
- PT Clock
- PT Clock Inverted
- Shared PT Clock
- Ground

### Clock Enable Multiplexer

Each macrocell has a 4:1 clock enable multiplexer. This allows the clock enable signal to be selected from the following four sources:

- PT Initialization/CE
- PT Initialization/CE Inverted
- Shared PT Clock
- Logic High

### Initialization Control

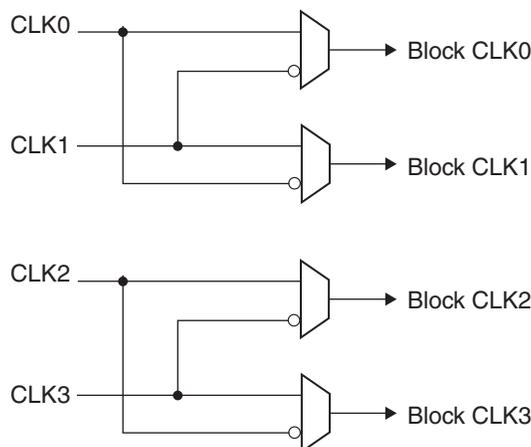
The ispMACH 4000 family architecture accommodates both block-level and macrocell-level set and reset capability. There is one block-level initialization term that is distributed to all macrocell registers in a GLB. At the macrocell level, two product terms can be “stolen” from the cluster associated with a macrocell to be used for set/reset functionality. A reset/preset swapping feature in each macrocell allows for reset and preset to be exchanged, providing flexibility.

Note that the reset/preset swapping selection feature affects power-up reset as well. All flip-flops power up to a known state for predictable system initialization. If a macrocell is configured to SET on a signal from the block-level initialization, then that macrocell will be SET during device power-up. If a macrocell is configured to RESET on a signal from the block-level initialization or is not configured for set/reset, then that macrocell will RESET on power-up. To guarantee initialization values, the  $V_{CC}$  rise must be monotonic, and the clock must be inactive until the reset delay time has elapsed.

### GLB Clock Generator

Each ispMACH 4000 device has up to four clock pins that are also routed to the GRP to be used as inputs. These pins drive a clock generator in each GLB, as shown in Figure 6. The clock generator provides four clock signals that can be used anywhere in the GLB. These four GLB clock signals can consist of a number of combinations of the true and complement edges of the global clock signals.

**Figure 6. GLB Clock Generator**



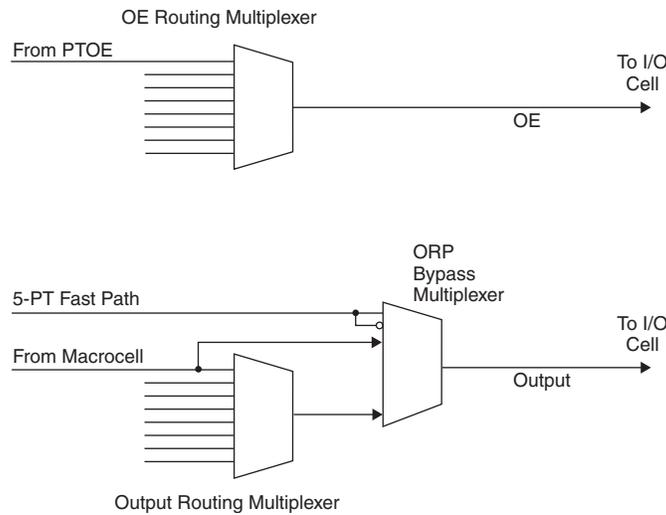
### Output Routing Pool (ORP)

The Output Routing Pool allows macrocell outputs to be connected to any of several I/O cells within an I/O block. This provides greater flexibility in determining the pinout and allows design changes to occur without affecting the pinout. The output routing pool also provides a parallel capability for routing macrocell-level OE product terms. This allows the OE product term to follow the macrocell output as it is switched between I/O cells. Additionally, the output routing pool allows the macrocell output or true and complement forms of the 5-PT bypass signal to bypass the output routing multiplexers and feed the I/O cell directly. The enhanced ORP of the ispMACH 4000 family consists of the following elements:

- Output Routing Multiplexers
- OE Routing Multiplexers
- Output Routing Pool Bypass Multiplexers

Figure 7 shows the structure of the ORP from the I/O cell perspective. This is referred to as an ORP slice. Each ORP has as many ORP slices as there are I/O cells in the corresponding I/O block.

**Figure 7. ORP Slice**



### Output Routing Multiplexers

The details of connections between the macrocells and the I/O cells vary across devices and within a device dependent on the maximum number of I/Os available. Tables 5-9 provide the connection details.

**Table 6. ORP Combinations for I/O Blocks with 8 I/Os**

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M2, M3, M4, M5, M6, M7, M8, M9
I/O 2	M4, M5, M6, M7, M8, M9, M10, M11
I/O 3	M6, M7, M8, M9, M10, M11, M12, M13
I/O 4	M8, M9, M10, M11, M12, M13, M14, M15
I/O 5	M10, M11, M12, M13, M14, M15, M0, M1
I/O 6	M12, M13, M14, M15, M0, M1, M2, M3
I/O 7	M14, M15, M0, M1, M2, M3, M4, M5

- LVTTTL
- LVC MOS 3.3
- LVC MOS 2.5
- LVC MOS 1.8
- 3.3V PCI Compatible

All of the I/Os and dedicated inputs have the capability to provide a bus-keeper latch, Pull-up Resistor or Pull-down Resistor. A fourth option is to provide none of these. The selection is done on a global basis. The default in both hardware and software is such that when the device is erased or if the user does not specify, the input structure is configured to be a Pull-up Resistor.

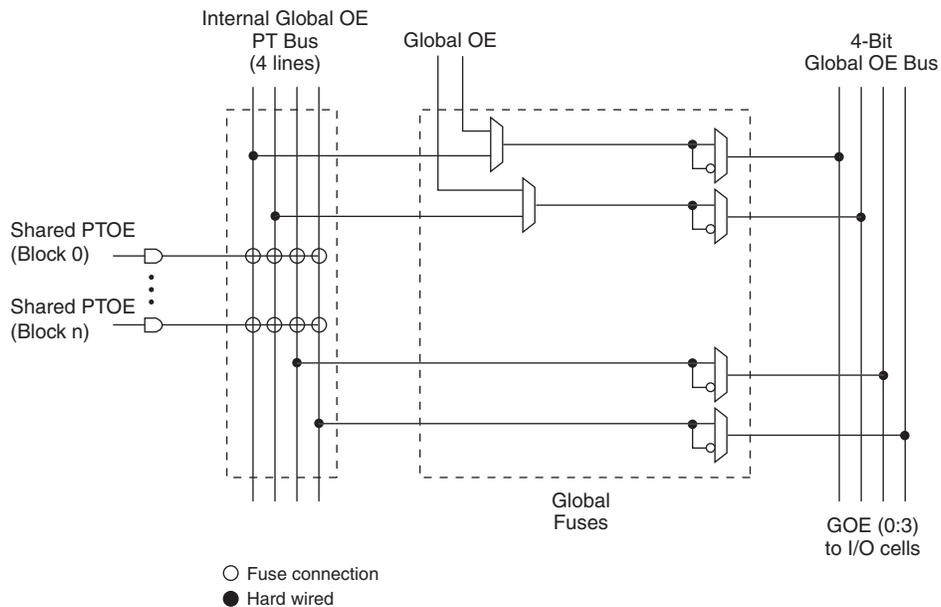
Each ispMACH 4000 device I/O has an individually programmable output slew rate control bit. Each output can be individually configured for fast slew or slow slew. The typical edge rate difference between fast and slow slew setting is 20%. For high-speed designs with long, unterminated traces, the slow-slew rate will introduce fewer reflections, less noise and keep ground bounce to a minimum. For designs with short traces or well terminated lines, the fast slew rate can be used to achieve the highest speed.

### Global OE Generation

Most ispMACH 4000 family devices have a 4-bit wide Global OE Bus, except the ispMACH 4032 device that has a 2-bit wide Global OE Bus. This bus is derived from a 4-bit internal global OE PT bus and two dual purpose I/O or GOE pins. Each signal that drives the bus can optionally be inverted.

Each GLB has a block-level OE PT that connects to all bits of the Global OE PT bus with four fuses. Hence, for a 256-macrocell device (with 16 blocks), each line of the bus is driven from 16 OE product terms. Figures 9 and 10 show a graphical representation of the global OE generation.

**Figure 9. Global OE Generation for All Devices Except ispMACH 4032**



### Absolute Maximum Ratings<sup>1, 2, 3</sup>

	ispMACH 4000C/Z (1.8V)	ispMACH 4000B (2.5V)	ispMACH 4000V (3.3V)
Supply Voltage ( $V_{CC}$ )	-0.5 to 2.5V	-0.5 to 5.5V	-0.5 to 5.5V
Output Supply Voltage ( $V_{CCO}$ )	-0.5 to 4.5V	-0.5 to 4.5V	-0.5 to 4.5V
Input or I/O Tristate Voltage Applied <sup>4, 5</sup>	-0.5 to 5.5V	-0.5 to 5.5V	-0.5 to 5.5V
Storage Temperature	-65 to 150°C	-65 to 150°C	-65 to 150°C
Junction Temperature ( $T_j$ ) with Power Applied	-55 to 150°C	-55 to 150°C	-55 to 150°C

1. Stress above those listed under the “Absolute Maximum Ratings” may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with Lattice [Thermal Management](#) document is required.
3. All voltages referenced to GND.
4. Undershoot of -2V and overshoot of ( $V_{IH}$  (MAX) + 2V), up to a total pin voltage of 6.0V, is permitted for a duration of < 20ns.
5. Maximum of 64 I/Os per device with  $V_{IN} > 3.6V$  is allowed.

### Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Units	
$V_{CC}$	Supply Voltage for 1.8V Devices	ispMACH 4000C	1.65	1.95	V
		ispMACH 4000Z	1.7	1.9	V
		ispMACH 4000Z, Extended Functional Voltage Operation	1.6 <sup>1, 2</sup>	1.9	V
	Supply Voltage for 2.5V Devices	2.3	2.7	V	
	Supply Voltage for 3.3V Devices	3.0	3.6	V	
$T_j$	Junction Temperature (Commercial)	0	90	C	
	Junction Temperature (Industrial)	-40	105	C	
	Junction Temperature (Extended)	-40	130	C	

1. Devices operating at 1.6V can expect performance degradation up to 35%.
2. Applicable for devices with 2004 date codes and later. Contact factory for ordering instructions.

### Erase Reprogram Specifications

Parameter	Min.	Max.	Units
Erase/Reprogram Cycle	1,000	—	Cycles

Note: Valid over commercial temperature range.

### Hot Socketing Characteristics<sup>1,2,3</sup>

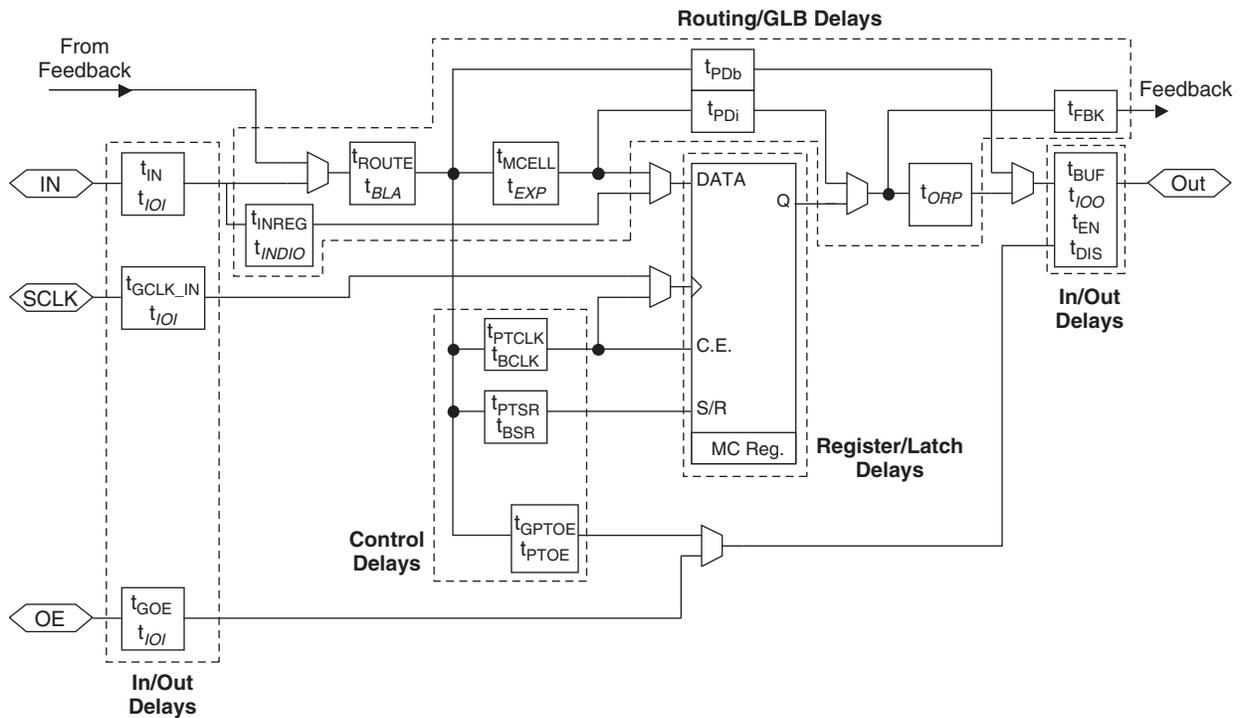
Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
$I_{DK}$	Input or I/O Leakage Current	$0 \leq V_{IN} \leq 3.0V, T_j = 105^\circ C$	—	±30	±150	µA
		$0 \leq V_{IN} \leq 3.0V, T_j = 130^\circ C$	—	±30	±200	µA

1. Insensitive to sequence of  $V_{CC}$  or  $V_{CCO}$ . However, assumes monotonic rise/fall rates for  $V_{CC}$  and  $V_{CCO}$ , provided  $(V_{IN} - V_{CCO}) \leq 3.6V$ .
2.  $0 < V_{CC} < V_{CC} (MAX), 0 < V_{CCO} < V_{CCO} (MAX)$ .
3.  $I_{DK}$  is additive to  $I_{PU}, I_{PD}$  or  $I_{BH}$ . Device defaults to pull-up until fuse circuitry is active.

## Timing Model

The task of determining the timing through the ispMACH 4000 family, like any CPLD, is relatively simple. The timing model provided in Figure 11 shows the specific delay paths. Once the implementation of a given function is determined either conceptually or from the software report file, the delay path of the function can easily be determined from the timing model. The Lattice design tools report the timing delays based on the same timing model for a particular design. Note that the internal timing parameters are given for reference only, and are not tested. The external timing parameters are tested and guaranteed for every device. For more information on the timing model and usage, refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#).

Figure 11. ispMACH 4000 Timing Model



Note: Italicized items are optional delay adders.

## ispMACH 4000Z Internal Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-45		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
<b>In/Out Delays</b>								
t <sub>IN</sub>	Input Buffer Delay	—	0.95	—	1.25	—	1.80	ns
t <sub>GOE</sub>	Global OE Pin Delay	—	3.00	—	3.50	—	4.30	ns
t <sub>GCLK_IN</sub>	Global Clock Input Buffer Delay	—	1.95	—	2.05	—	2.15	ns
t <sub>BUF</sub>	Delay through Output Buffer	—	1.10	—	1.00	—	1.30	ns
t <sub>EN</sub>	Output Enable Time	—	2.50	—	2.50	—	2.70	ns
t <sub>DIS</sub>	Output Disable Time	—	2.50	—	2.50	—	2.70	ns
<b>Routing/GLB Delays</b>								
t <sub>ROUTE</sub>	Delay through GRP	—	2.25	—	2.05	—	2.50	ns
t <sub>MCELL</sub>	Macrocell Delay	—	0.65	—	0.65	—	1.00	ns
t <sub>INREG</sub>	Input Buffer to Macrocell Register Delay	—	1.00	—	1.00	—	1.00	ns
t <sub>FBK</sub>	Internal Feedback Delay	—	0.35	—	0.05	—	0.05	ns
t <sub>PDb</sub>	5-PT Bypass Propagation Delay	—	0.20	—	0.70	—	1.90	ns
t <sub>PDi</sub>	Macrocell Propagation Delay	—	0.45	—	0.65	—	1.00	ns
<b>Register/Latch Delays</b>								
t <sub>S</sub>	D-Register Setup Time (Global Clock)	1.00	—	1.10	—	1.35	—	ns
t <sub>S_PT</sub>	D-Register Setup Time (Product Term Clock)	2.10	—	1.90	—	2.45	—	ns
t <sub>ST</sub>	T-Register Setup Time (Global Clock)	1.20	—	1.30	—	1.55	—	ns
t <sub>ST_PT</sub>	T-register Setup Time (Product Term Clock)	2.30	—	2.10	—	2.75	—	ns
t <sub>H</sub>	D-Register Hold Time	1.90	—	1.90	—	3.15	—	ns
t <sub>HT</sub>	T-Resister Hold Time	1.90	—	1.90	—	3.15	—	ns
t <sub>SIR</sub>	D-Input Register Setup Time (Global Clock)	1.30	—	1.10	—	0.75	—	ns
t <sub>SIR_PT</sub>	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	1.45	—	ns
t <sub>HIR</sub>	D-Input Register Hold Time (Global Clock)	1.30	—	1.50	—	1.95	—	ns
t <sub>HIR_PT</sub>	D-Input Register Hold Time (Product Term Clock)	1.00	—	1.00	—	1.18	—	ns
t <sub>COi</sub>	Register Clock to Output/Feedback MUX Time	—	0.75	—	1.15	—	1.05	ns
t <sub>CES</sub>	Clock Enable Setup Time	2.00	—	2.00	—	2.00	—	ns
t <sub>CEH</sub>	Clock Enable Hold Time	0.00	—	0.00	—	0.00	—	ns
t <sub>SL</sub>	Latch Setup Time (Global Clock)	1.00	—	1.00	—	1.65	—	ns
t <sub>SL_PT</sub>	Latch Setup Time (Product Term Clock)	2.10	—	1.90	—	2.15	—	ns
t <sub>HL</sub>	Latch Hold Time	2.00	—	2.00	—	1.17	—	ns
t <sub>GOi</sub>	Latch Gate to Output/Feedback MUX Time	—	0.33	—	0.33	—	0.33	ns
t <sub>PDLi</sub>	Propagation Delay through Transparent Latch to Output/Feedback MUX	—	0.25	—	0.25	—	0.25	ns
t <sub>SRI</sub>	Asynchronous Reset or Set to Output/Feedback MUX Delay	—	0.97	—	0.97	—	0.28	ns
t <sub>SRR</sub>	Asynchronous Reset or Set Recovery Delay	—	1.80	—	1.80	—	1.67	ns
<b>Control Delays</b>								
t <sub>BCLK</sub>	GLB PT Clock Delay	—	1.55	—	1.55	—	1.25	ns
t <sub>PTCLK</sub>	Macrocell PT Clock Delay	—	1.55	—	1.55	—	1.25	ns
t <sub>BSR</sub>	GLB PT Set/Reset Delay	—	1.83	—	1.83	—	1.83	ns
t <sub>PTSR</sub>	Macrocell PT Set/Reset Delay	—	1.83	—	1.83	—	2.72	ns
t <sub>GPTOE</sub>	Global PT OE Delay	—	4.30	—	4.20	—	3.50	ns

ispMACH 4000V/B/C Timing Adders<sup>1</sup>

Adder Type	Base Parameter	Description	-25		-27		-3		-35		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>											
t <sub>INDIO</sub>	t <sub>INREG</sub>	Input register delay	—	0.95	—	1.00	—	1.00	—	1.00	ns
t <sub>EXP</sub>	t <sub>MCELL</sub>	Product term expander delay	—	0.33	—	0.33	—	0.33	—	0.33	ns
t <sub>ORP</sub>	—	Output routing pool delay	—	0.05	—	0.05	—	0.05	—	0.05	ns
t <sub>BLA</sub>	t <sub>ROUTE</sub>	Additional block loading adder	—	0.03	—	0.05	—	0.05	—	0.05	ns
<b>t<sub>IOI</sub> Input Adjusters</b>											
LVTTTL_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	—	0.00	ns
PCI_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using PCI compatible input	—	0.60	—	0.60	—	0.60	—	0.60	ns
<b>t<sub>IOO</sub> Output Adjusters</b>											
LVTTTL_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	—	0.00	ns
PCI_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t <sub>BUF</sub> , t <sub>EN</sub>	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

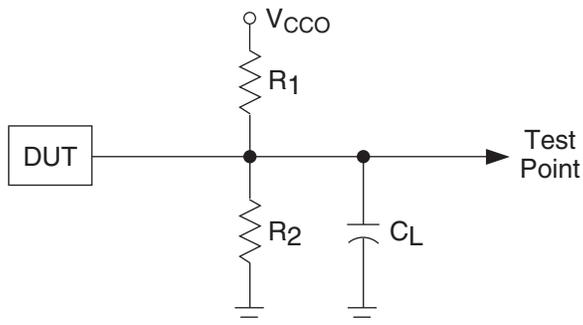
Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

### Switching Test Conditions

Figure 12 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 11.

**Figure 12. Output Test Load, LVTTTL and LVCMOS Standards**



0213A/ispm4k

**Table 11. Test Fixture Required Components**

Test Condition	R <sub>1</sub>	R <sub>2</sub>	C <sub>L</sub> <sup>1</sup>	Timing Ref.	V <sub>CCO</sub>
LVCMOS I/O, (L -> H, H -> L)	106Ω	106Ω	35pF	LVCMOS 3.3 = 1.5V	LVCMOS 3.3 = 3.0V
				LVCMOS 2.5 = V <sub>CCO</sub> /2	LVCMOS 2.5 = 2.3V
				LVCMOS 1.8 = V <sub>CCO</sub> /2	LVCMOS 1.8 = 1.65V
LVCMOS I/O (Z -> H)	∞	106Ω	35pF	1.5V	3.0V
LVCMOS I/O (Z -> L)	106Ω	∞	35pF	1.5V	3.0V
LVCMOS I/O (H -> Z)	∞	106Ω	5pF	V <sub>OH</sub> - 0.3	3.0V
LVCMOS I/O (L -> Z)	106Ω	∞	5pF	V <sub>OL</sub> + 0.3	3.0V

1. C<sub>L</sub> includes test fixtures and probe capacitance.

**ispMACH 4032V/B/C and 4064V/B/C Logic Signal Connections:  
44-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4032V/B/C		ispMACH 4064V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
42	0	A2	A <sup>2</sup>	A4	A <sup>2</sup>
43	0	A3	A <sup>3</sup>	A6	A <sup>3</sup>
44	0	A4	A <sup>4</sup>	A8	A <sup>4</sup>

**ispMACH 4032V/B/C/Z and 4064V/B/C/Z Logic Signal Connections:  
48-Pin TQFP**

Pin Number	Bank Number	ispMACH 4032V/B/C/Z		ispMACH 4064V/B/C		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	TDI	-	TDI	-	TDI	-
2	0	A5	A <sup>5</sup>	A10	A <sup>5</sup>	A8	A <sup>5</sup>
3	0	A6	A <sup>6</sup>	A12	A <sup>6</sup>	A10	A <sup>6</sup>
4	0	A7	A <sup>7</sup>	A14	A <sup>7</sup>	A11	A <sup>7</sup>
5	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
6	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
7	0	A8	A <sup>8</sup>	B0	B <sup>0</sup>	B15	B <sup>7</sup>
8	0	A9	A <sup>9</sup>	B2	B <sup>1</sup>	B12	B <sup>6</sup>
9	0	A10	A <sup>10</sup>	B4	B <sup>2</sup>	B10	B <sup>5</sup>
10	0	A11	A <sup>11</sup>	B6	B <sup>3</sup>	B8	B <sup>4</sup>
11	-	TCK	-	TCK	-	TCK	-
12	-	VCC	-	VCC	-	VCC	-
13	-	GND	-	GND	-	GND	-
14	0	A12	A <sup>12</sup>	B8	B <sup>4</sup>	B6	B <sup>3</sup>
15	0	A13	A <sup>13</sup>	B10	B <sup>5</sup>	B4	B <sup>2</sup>
16	0	A14	A <sup>14</sup>	B12	B <sup>6</sup>	B2	B <sup>1</sup>
17	0	A15	A <sup>15</sup>	B14	B <sup>7</sup>	B0	B <sup>0</sup>
18	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
19	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
20	1	B0	B <sup>0</sup>	C0	C <sup>0</sup>	C0	C <sup>0</sup>
21	1	B1	B <sup>1</sup>	C2	C <sup>1</sup>	C1	C <sup>1</sup>
22	1	B2	B <sup>2</sup>	C4	C <sup>2</sup>	C2	C <sup>2</sup>
23	1	B3	B <sup>3</sup>	C6	C <sup>3</sup>	C4	C <sup>3</sup>
24	1	B4	B <sup>4</sup>	C8	C <sup>4</sup>	C6	C <sup>4</sup>
25	-	TMS	-	TMS	-	TMS	-
26	1	B5	B <sup>5</sup>	C10	C <sup>5</sup>	C8	C <sup>5</sup>
27	1	B6	B <sup>6</sup>	C12	C <sup>6</sup>	C10	C <sup>6</sup>
28	1	B7	B <sup>7</sup>	C14	C <sup>7</sup>	C11	C <sup>7</sup>
29	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
30	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
31	1	B8	B <sup>8</sup>	D0	D <sup>0</sup>	D15	D <sup>7</sup>
32	1	B9	B <sup>9</sup>	D2	D <sup>1</sup>	D12	D <sup>6</sup>

**ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections:  
100-Pin TQFP**

Pin Number	Bank Number	ispMACH 4064V/B/C/Z		ispMACH 4128V/B/C/Z		ispMACH 4256V/B/C/Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	GND	-	GND	-	GND	-
2	-	TDI	-	TDI	-	TDI	-
3	0	A8	A^8	B0	B^0	C12	C^3
4	0	A9	A^9	B2	B^1	C10	C^2
5	0	A10	A^10	B4	B^2	C6	C^1
6	0	A11	A^11	B6	B^3	C2	C^0
7	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
8	0	A12	A^12	B8	B^4	D12	D^3
9	0	A13	A^13	B10	B^5	D10	D^2
10	0	A14	A^14	B12	B^6	D6	D^1
11	0	A15	A^15	B13	B^7	D4	D^0
12*	0	I	-	I	-	I	-
13	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
14	0	B15	B^15	C14	C^7	E4	E^0
15	0	B14	B^14	C12	C^6	E6	E^1
16	0	B13	B^13	C10	C^5	E10	E^2
17	0	B12	B^12	C8	C^4	E12	E^3
18	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
19	0	B11	B^11	C6	C^3	F2	F^0
20	0	B10	B^10	C5	C^2	F6	F^1
21	0	B9	B^9	C4	C^1	F10	F^2
22	0	B8	B^8	C2	C^0	F12	F^3
23*	0	I	-	I	-	I	-
24	-	TCK	-	TCK	-	TCK	-
25	-	VCC	-	VCC	-	VCC	-
26	-	GND	-	GND	-	GND	-
27*	0	I	-	I	-	I	-
28	0	B7	B^7	D13	D^7	G12	G^3
29	0	B6	B^6	D12	D^6	G10	G^2
30	0	B5	B^5	D10	D^5	G6	G^1
31	0	B4	B^4	D8	D^4	G2	G^0
32	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
33	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
34	0	B3	B^3	D6	D^3	H12	H^3
35	0	B2	B^2	D4	D^2	H10	H^2
36	0	B1	B^1	D2	D^1	H6	H^1
37	0	B0	B^0	D0	D^0	H2	H^0
38	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
39	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
40	-	VCC	-	VCC	-	VCC	-
41	1	C0	C^0	E0	E^0	I2	I^0

**ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
62	1	E10	E <sup>8</sup>
63	1	E12	E <sup>9</sup>
64	1	E14	E <sup>11</sup>
65	1	GND	-
66	1	TMS	-
67	1	VCCO (Bank 1)	-
68	1	F0	F <sup>0</sup>
69	1	F1	F <sup>1</sup>
70	1	F2	F <sup>2</sup>
71	1	F4	F <sup>3</sup>
72	1	F5	F <sup>4</sup>
73	1	F6	F <sup>5</sup>
74	1	GND (Bank 1)	-
75	1	F8	F <sup>6</sup>
76	1	F9	F <sup>7</sup>
77	1	F10	F <sup>8</sup>
78	1	F12	F <sup>9</sup>
79	1	F13	F <sup>10</sup>
80	1	F14	F <sup>11</sup>
81	1	VCCO (Bank 1)	-
82	1	G14	G <sup>11</sup>
83	1	G13	G <sup>10</sup>
84	1	G12	G <sup>9</sup>
85	1	G10	G <sup>8</sup>
86	1	G9	G <sup>7</sup>
87	1	G8	G <sup>6</sup>
88	1	GND (Bank 1)	-
89	1	G6	G <sup>5</sup>
90	1	G5	G <sup>4</sup>
91	1	G4	G <sup>3</sup>
92	1	G2	G <sup>2</sup>
93	1	G0	G <sup>0</sup>
94	1	VCCO (Bank 1)	-
95	1	TDO	-
96	1	VCC	-
97	1	GND	-
98	1	H14	H <sup>11</sup>
99	1	H13	H <sup>10</sup>
100	1	H12	H <sup>9</sup>
101	1	H10	H <sup>8</sup>
102	1	H9	H <sup>7</sup>
103	1	H8	H <sup>6</sup>
104	1	GND (Bank 1)	-

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:  
132-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
E3	0	NC	-	B8	B^6	D12	D^6
F2	0	A12	A^12	B9	B^7	D10	D^5
F1	0	A13	A^13	B10	B^8	D8	D^4
F3	0	A14	A^14	B12	B^9	D6	D^3
G1	0	A15	A^15	B13	B^10	D4	D^2
G2	0	I	-	B14	B^11	D2	D^1
G3	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
H2	0	NC	-	C14	C^11	E2	E^1
H1	0	B15	B^15	C13	C^10	E4	E^2
H3	0	B14	B^14	C12	C^9	E6	E^3
J1	0	B13	B^13	C10	C^8	E8	E^4
J2	0	B12	B^12	C9	C^7	E10	E^5
J3	0	NC	-	C8	C^6	E12	E^6
K2	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
K1	0	NC	-	C6	C^5	F2	F^1
K3	0	B11	B^11	C5	C^4	F4	F^2
L2	0	B10	B^10	C4	C^3	F6	F^3
L1	0	B9	B^9	C2	C^2	F8	F^4
L3	0	B8	B^8	C1	C^1	F10	F^5
M1	0	I	-	C0	C^0	F12	F^6
M2	0	NC	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
N1	-	TCK	-	TCK	-	TCK	-
P1	-	VCC	-	VCC	-	VCC	-
P2	-	GND	-	GND	-	GND	-
N2	0	I	-	D14	D^11	G12	G^6
P3	0	B7	B^7	D13	D^10	G10	G^5
M3	0	B6	B^6	D12	D^9	G8	G^4
N3	0	B5	B^5	D10	D^8	G6	G^3
P4	0	B4	B^4	D9	D^7	G4	G^2
M4	0	NC	-	D8	D^6	G2	G^1
N4	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
P5	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
N5	0	NC	-	D6	D^5	H12	H^6
M5	0	B3	B^3	D5	D^4	H10	H^5
N6	0	B2	B^2	D4	D^3	H8	H^4
P6	0	B1	B^1	D2	D^2	H6	H^3
M6	0	B0	B^0	D1	D^1	H4	H^2
P7	0	NC	-	D0	D^0	H2	H^1
N7	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
M7	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
N8	-	VCC	-	VCC	-	VCC	-

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:  
132-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
P8	1	NC <sup>1</sup>	-	NC <sup>1</sup>	-	I <sup>1</sup>	-
M8	1	NC	-	E0	E <sup>0</sup>	I2	I <sup>1</sup>
P9	1	C0	C <sup>0</sup>	E1	E <sup>1</sup>	I4	I <sup>2</sup>
N9	1	C1	C <sup>1</sup>	E2	E <sup>2</sup>	I6	I <sup>3</sup>
M9	1	C2	C <sup>2</sup>	E4	E <sup>3</sup>	I8	I <sup>4</sup>
N10	1	C3	C <sup>3</sup>	E5	E <sup>4</sup>	I10	I <sup>5</sup>
P10	1	NC	-	E6	E <sup>5</sup>	I12	I <sup>6</sup>
M10	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
N11	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
P11	1	NC	-	E8	E <sup>6</sup>	J2	J <sup>1</sup>
M11	1	C4	C <sup>4</sup>	E9	E <sup>7</sup>	J4	J <sup>2</sup>
P12	1	C5	C <sup>5</sup>	E10	E <sup>8</sup>	J6	J <sup>3</sup>
N12	1	C6	C <sup>6</sup>	E12	E <sup>9</sup>	J8	J <sup>4</sup>
P13	1	C7	C <sup>7</sup>	E13	E <sup>10</sup>	J10	J <sup>5</sup>
P14	1	NC	-	E14	E <sup>11</sup>	J12	J <sup>6</sup>
N14	-	GND	-	GND	-	GND	-
N13	-	TMS	-	TMS	-	TMS	-
M14	1	NC	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
M12	1	NC	-	F0	F <sup>0</sup>	K12	K <sup>6</sup>
M13	1	C8	C <sup>8</sup>	F1	F <sup>1</sup>	K10	K <sup>5</sup>
L14	1	C9	C <sup>9</sup>	F2	F <sup>2</sup>	K8	K <sup>4</sup>
L12	1	C10	C <sup>10</sup>	F4	F <sup>3</sup>	K6	K <sup>3</sup>
L13	1	C11	C <sup>11</sup>	F5	F <sup>4</sup>	K4	K <sup>2</sup>
K14	1	NC	-	F6	F <sup>5</sup>	K2	K <sup>1</sup>
K13	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
K12	1	NC	-	F8	F <sup>6</sup>	L12	L <sup>6</sup>
J13	1	C12	C <sup>12</sup>	F9	F <sup>7</sup>	L10	L <sup>5</sup>
J14	1	C13	C <sup>13</sup>	F10	F <sup>8</sup>	L8	L <sup>4</sup>
J12	1	C14	C <sup>14</sup>	F12	F <sup>9</sup>	L6	L <sup>3</sup>
H14	1	C15	C <sup>15</sup>	F13	F <sup>10</sup>	L4	L <sup>2</sup>
H13	1	I	-	F14	F <sup>11</sup>	L2	L <sup>1</sup>
H12	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
G13	1	NC	-	G14	G <sup>11</sup>	M2	M <sup>1</sup>
G14	1	NC	-	G13	G <sup>10</sup>	M4	M <sup>2</sup>
G12	1	D15	D <sup>15</sup>	G12	G <sup>9</sup>	M6	M <sup>3</sup>
F14	1	D14	D <sup>14</sup>	G10	G <sup>8</sup>	M8	M <sup>4</sup>
F13	1	D13	D <sup>13</sup>	G9	G <sup>7</sup>	M10	M <sup>5</sup>
F12	1	D12	D <sup>12</sup>	G8	G <sup>6</sup>	M12	M <sup>6</sup>
E13	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
E14	1	NC	-	G6	G <sup>5</sup>	N2	N <sup>1</sup>
E12	1	D11	D <sup>11</sup>	G5	G <sup>4</sup>	N4	N <sup>2</sup>

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:  
132-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
D13	1	D10	D <sup>10</sup>	G4	G <sup>3</sup>	N6	N <sup>3</sup>
D14	1	D9	D <sup>9</sup>	G2	G <sup>2</sup>	N8	N <sup>4</sup>
D12	1	D8	D <sup>8</sup>	G1	G <sup>1</sup>	N10	N <sup>5</sup>
C14	1	I	-	G0	G <sup>0</sup>	N12	N <sup>6</sup>
C13	1	NC	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
B14	-	TDO	-	TDO	-	TDO	-
A14	-	VCC	-	VCC	-	VCC	-
A13	-	GND	-	GND	-	GND	-
B13	1	NC	-	H14	H <sup>11</sup>	O12	O <sup>6</sup>
A12	1	I	-	H13	H <sup>10</sup>	O10	O <sup>5</sup>
C12	1	D7	D <sup>7</sup>	H12	H <sup>9</sup>	O8	O <sup>4</sup>
B12	1	D6	D <sup>6</sup>	H10	H <sup>8</sup>	O6	O <sup>3</sup>
A11	1	D5	D <sup>5</sup>	H9	H <sup>7</sup>	O4	O <sup>2</sup>
C11	1	D4	D <sup>4</sup>	H8	H <sup>6</sup>	O2	O <sup>1</sup>
B11	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
A10	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
B10	1	NC	-	H6	H <sup>5</sup>	P12	P <sup>6</sup>
C10	1	NC	-	H5	H <sup>4</sup>	P10	P <sup>5</sup>
B9	1	D3	D <sup>3</sup>	H4	H <sup>3</sup>	P8	P <sup>4</sup>
A9	1	D2	D <sup>2</sup>	H2	H <sup>2</sup>	P6	P <sup>3</sup>
C9	1	D1	D <sup>1</sup>	H1	H <sup>1</sup>	P4	P <sup>2</sup>
A8	1	D0/GOE1	D <sup>0</sup>	H0/GOE1	H <sup>0</sup>	P2/GOE1	P <sup>1</sup>
B8	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
C8	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
B7	-	VCC	-	VCC	-	VCC	-
A7	0	NC <sup>1</sup>	-	NC <sup>1</sup>	-	I <sup>1</sup>	-
C7	0	A0/GOE0	A <sup>0</sup>	A0/GOE0	A <sup>0</sup>	A2/GOE0	A <sup>1</sup>
A6	0	A1	A <sup>1</sup>	A1	A <sup>1</sup>	A4	A <sup>2</sup>
B6	0	A2	A <sup>2</sup>	A2	A <sup>2</sup>	A6	A <sup>3</sup>
C6	0	A3	A <sup>3</sup>	A4	A <sup>3</sup>	A8	A <sup>4</sup>
B5	0	NC	-	A5	A <sup>4</sup>	A10	A <sup>5</sup>
A5	0	NC	-	A6	A <sup>5</sup>	A12	A <sup>6</sup>
C5	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
B4	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
A4	0	NC	-	A8	A <sup>6</sup>	B2	B <sup>1</sup>
C4	0	A4	A <sup>4</sup>	A9	A <sup>7</sup>	B4	B <sup>2</sup>
A3	0	A5	A <sup>5</sup>	A10	A <sup>8</sup>	B6	B <sup>3</sup>
B3	0	A6	A <sup>6</sup>	A12	A <sup>9</sup>	B8	B <sup>4</sup>
A2	0	A7	A <sup>7</sup>	A13	A <sup>10</sup>	B10	B <sup>5</sup>
A1	0	NC	-	A14	A <sup>11</sup>	B12	B <sup>6</sup>

1. For device migration considerations, these NC pins are input signal pins in ispMACH 4256Z device.

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
142	1	O0	O <sup>0</sup>	GX0	GX <sup>0</sup>	OX0	OX <sup>0</sup>
143	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
144	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
145	1	P14	P <sup>7</sup>	HX14	HX <sup>7</sup>	PX14	PX <sup>7</sup>
146	1	P12	P <sup>6</sup>	HX12	HX <sup>6</sup>	PX12	PX <sup>6</sup>
147	1	P10	P <sup>5</sup>	HX10	HX <sup>5</sup>	PX10	PX <sup>5</sup>
148	1	P8	P <sup>4</sup>	HX8	HX <sup>4</sup>	PX8	PX <sup>4</sup>
149	1	P6	P <sup>3</sup>	HX6	HX <sup>3</sup>	PX6	PX <sup>3</sup>
150	1	P4	P <sup>2</sup>	HX4	HX <sup>2</sup>	PX4	PX <sup>2</sup>
151	1	P2/GOE1	P <sup>1</sup>	HX2/GOE1	HX <sup>1</sup>	PX2/GOE1	PX <sup>1</sup>
152	1	P0	P <sup>0</sup>	HX0	HX <sup>0</sup>	PX0	PX <sup>0</sup>
153	-	GND	-	GND	-	GND	-
154	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
155	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
156	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
157	-	VCC	-	VCC	-	VCC	-
158	0	A0	A <sup>0</sup>	A0	A <sup>0</sup>	A0	A <sup>0</sup>
159	0	A2/GOE0	A <sup>1</sup>	A2/GOE0	A <sup>1</sup>	A2/GOE0	A <sup>1</sup>
160	0	A4	A <sup>2</sup>	A4	A <sup>2</sup>	A4	A <sup>2</sup>
161	0	A6	A <sup>3</sup>	A6	A <sup>3</sup>	A6	A <sup>3</sup>
162	0	A8	A <sup>4</sup>	A8	A <sup>4</sup>	A8	A <sup>4</sup>
163	0	A10	A <sup>5</sup>	A10	A <sup>5</sup>	A10	A <sup>5</sup>
164	0	A12	A <sup>6</sup>	A12	A <sup>6</sup>	A12	A <sup>6</sup>
165	0	A14	A <sup>7</sup>	A14	A <sup>7</sup>	A14	A <sup>7</sup>
166	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
167	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
168	0	B0	B <sup>0</sup>	B0	B <sup>0</sup>	B0	B <sup>0</sup>
169	0	B2	B <sup>1</sup>	B2	B <sup>1</sup>	B2	B <sup>1</sup>
170	0	B4	B <sup>2</sup>	B4	B <sup>2</sup>	B4	B <sup>2</sup>
171	0	B6	B <sup>3</sup>	B6	B <sup>3</sup>	B6	B <sup>3</sup>
172	0	B8	B <sup>4</sup>	B8	B <sup>4</sup>	B8	B <sup>4</sup>
173	0	B10	B <sup>5</sup>	B10	B <sup>5</sup>	B10	B <sup>5</sup>
174	0	B12	B <sup>6</sup>	B12	B <sup>6</sup>	B12	B <sup>6</sup>
175	0	B14	B <sup>7</sup>	B14	B <sup>7</sup>	B14	B <sup>7</sup>
176	-	VCC	-	VCC	-	VCC	-

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:  
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
J6	0	E14	E^7	E10	E^7	H14	H^7	J14	J^7
K3	0	NC	-	E12	E^8	G0	G^0	I0	I^0
K4	0	NC	-	E14	E^9	G2	G^1	I4	I^1
L1	0	NC	-	NC	-	I14	I^7	K0	K^0
L2	0	NC	-	NC	-	I12	I^6	K2	K^1
M1	0	NC	-	NC	-	NC	-	K4	K^2
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
-	0	-	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
M2	0	NC	-	NC	-	NC	-	K6	K^3
N1	0	NC	-	NC	-	I10	I^5	K8	K^4
M3	0	NC	-	NC	-	I8	I^4	K10	K^5
M4	0	NC	-	F0	F^0	G4	G^2	I8	I^2
N2	0	NC	-	F1	F^1	G6	G^3	I12	I^3
K5	0	F0	F^0	F2	F^2	J0	J^0	N0	N^0
P1	0	F2	F^1	F4	F^3	J2	J^1	N2	N^1
K6	0	F4	F^2	F6	F^4	J4	J^2	N4	N^2
N3	0	F6	F^3	F8	F^5	J6	J^3	N6	N^3
L5	0	F8	F^4	F9	F^6	J8	J^4	N8	N^4
P2	0	F10	F^5	F10	F^7	J10	J^5	N10	N^5
L6	0	F12	F^6	F12	F^8	J12	J^6	N12	N^6
R1	0	F14	F^7	F14	F^9	J14	J^7	N14	N^7
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
P3	-	TCK	-	TCK	-	TCK	-	TCK	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
-	-	GND	-	GND	-	GND	-	GND	-
-	0	-	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
T2	0	NC	-	G14	G^9	I6	I^3	K12	K^6
M5	0	NC	-	G12	G^8	I4	I^2	K14	K^7
N4	0	G14	G^7	G10	G^7	K14	K^7	O14	O^7
T3	0	G12	G^6	G9	G^6	K12	K^6	O12	O^6
R3	0	G10	G^5	G8	G^5	K10	K^5	O10	O^5
M6	0	G8	G^4	G6	G^4	K8	K^4	O8	O^4
P4	0	G6	G^3	G4	G^3	K6	K^3	O6	O^3
L7	0	G4	G^2	G2	G^2	K4	K^2	O4	O^2
N5	0	G2	G^1	G1	G^1	K2	K^1	O2	O^1
M7	0	G0	G^0	G0	G^0	K0	K^0	O0	O^0
P5	0	NC	-	NC	-	G8	G^4	M0	M^0
R4	0	NC	-	NC	-	G10	G^5	M4	M^1
T4	0	NC	-	NC	-	NC	-	L0	L^0
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-

## ispMACH 4000ZC (1.8V, Zero Power) Industrial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4064ZC	LC4064ZC-5M132I	64	1.8	5	csBGA	132	64	I
	LC4064ZC-75M132I	64	1.8	7.5	csBGA	132	64	I
	LC4064ZC-5T100I	64	1.8	5	TQFP	100	64	I
	LC4064ZC-75T100I	64	1.8	7.5	TQFP	100	64	I
	LC4064ZC-5M56I	64	1.8	5	csBGA	56	34	I
	LC4064ZC-75M56I	64	1.8	7.5	csBGA	56	34	I
	LC4064ZC-5T48I	64	1.8	5	TQFP	48	32	I
	LC4064ZC-75T48I	64	1.8	7.5	TQFP	48	32	I
LC4128ZC	LC4128ZC-75M132I	128	1.8	7.5	csBGA	132	96	I
	LC4128ZC-75T100I	128	1.8	7.5	TQFP	100	64	I
LC4256ZC	LC4256ZC-75T176I	256	1.8	7.5	TQFP	176	128	I
	LC4256ZC-75M132I	256	1.8	7.5	csBGA	132	96	I
	LC4256ZC-75T100I	256	1.8	7.5	TQFP	100	64	I

## ispMACH 4000ZC (1.8V, Zero Power) Extended Temperature Devices

Family	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032ZC	LC4032ZC-75T48E	32	1.8	7.5	TQFP	48	32	E
LC4064ZC	LC4064ZC-75T100E	64	1.8	7.5	TQFP	100	64	E
	LC4064ZC-75T48E	64	1.8	7.5	TQFP	48	32	E
LC4128ZC	LC4128ZC-75T100E	128	1.8	7.5	TQFP	100	64	E
LC4256ZC	LC4256ZC-75T176E	256	1.8	7.5	TQFP	176	128	E
	LC4256ZC-75T100E	256	1.8	7.5	TQFP	100	64	E

## ispMACH 4000C (1.8V) Commercial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032C	LC4032C-25T48C	32	1.8	2.5	TQFP	48	32	C
	LC4032C-5T48C	32	1.8	5	TQFP	48	32	C
	LC4032C-75T48C	32	1.8	7.5	TQFP	48	32	C
	LC4032C-25T44C	32	1.8	2.5	TQFP	44	30	C
	LC4032C-5T44C	32	1.8	5	TQFP	44	30	C
	LC4032C-75T44C	32	1.8	7.5	TQFP	44	30	C
LC4064C	LC4064C-25T100C	64	1.8	2.5	TQFP	100	64	C
	LC4064C-5T100C	64	1.8	5	TQFP	100	64	C
	LC4064C-75T100C	64	1.8	7.5	TQFP	100	64	C
	LC4064C-25T48C	64	1.8	2.5	TQFP	48	32	C
	LC4064C-5T48C	64	1.8	5	TQFP	48	32	C
	LC4064C-75T48C	64	1.8	7.5	TQFP	48	32	C
	LC4064C-25T44C	64	1.8	2.5	TQFP	44	30	C
	LC4064C-5T44C	64	1.8	5	TQFP	44	30	C
LC4064C-75T44C	64	1.8	7.5	TQFP	44	30	C	

## ispMACH 4000B (2.5V) Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4256B	LC4256B-3FT256AC	256	2.5	3	ftBGA	256	128	C
	LC4256B-5FT256AC	256	2.5	5	ftBGA	256	128	C
	LC4256B-75FT256AC	256	2.5	7.5	ftBGA	256	128	C
	LC4256B-3FT256BC	256	2.5	3	ftBGA	256	160	C
	LC4256B-5FT256BC	256	2.5	5	ftBGA	256	160	C
	LC4256B-75FT256BC	256	2.5	7.5	ftBGA	256	160	C
	LC4256B-3F256AC <sup>1</sup>	256	2.5	3	fpBGA	256	128	C
	LC4256B-5F256AC <sup>1</sup>	256	2.5	5	fpBGA	256	128	C
	LC4256B-75F256AC <sup>1</sup>	256	2.5	7.5	fpBGA	256	128	C
	LC4256B-3F256BC <sup>1</sup>	256	2.5	3	fpBGA	256	160	C
	LC4256B-5F256BC <sup>1</sup>	256	2.5	5	fpBGA	256	160	C
	LC4256B-75F256BC <sup>1</sup>	256	2.5	7.5	fpBGA	256	160	C
	LC4256B-3T176C	256	2.5	3	TQFP	176	128	C
	LC4256B-5T176C	256	2.5	5	TQFP	176	128	C
	LC4256B-75T176C	256	2.5	7.5	TQFP	176	128	C
	LC4256B-3T100C	256	2.5	3	TQFP	100	64	C
LC4256B-5T100C	256	2.5	5	TQFP	100	64	C	
LC4256B-75T100C	256	2.5	7.5	TQFP	100	64	C	
LC4384B	LC4384B-35FT256C	384	2.5	3.5	ftBGA	256	192	C
	LC4384B-5FT256C	384	2.5	5	ftBGA	256	192	C
	LC4384B-75FT256C	384	2.5	7.5	ftBGA	256	192	C
	LC4384B-35F256C <sup>1</sup>	384	2.5	3.5	fpBGA	256	192	C
	LC4384B-5F256C <sup>1</sup>	384	2.5	5	fpBGA	256	192	C
	LC4384B-75F256C <sup>1</sup>	384	2.5	7.5	fpBGA	256	192	C
	LC4384B-35T176C	384	2.5	3.5	TQFP	176	128	C
	LC4384B-5T176C	384	2.5	5	TQFP	176	128	C
	LC4384B-75T176C	384	2.5	7.5	TQFP	176	128	C
LC4512B	LC4512B-35FT256C	512	2.5	3.5	ftBGA	256	208	C
	LC4512B-5FT256C	512	2.5	5	ftBGA	256	208	C
	LC4512B-75FT256C	512	2.5	7.5	ftBGA	256	208	C
	LC4512B-35F256C <sup>1</sup>	512	2.5	3.5	fpBGA	256	208	C
	LC4512B-5F256C <sup>1</sup>	512	2.5	5	fpBGA	256	208	C
	LC4512B-75F256C <sup>1</sup>	512	2.5	7.5	fpBGA	256	208	C
	LC4512B-35T176C	512	2.5	3.5	TQFP	176	128	C
	LC4512B-5T176C	512	2.5	5	TQFP	176	128	C
	LC4512B-75T176C	512	2.5	7.5	TQFP	176	128	C

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

## ispMACH 4000V (3.3V) Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4128V	LC4128V-27T144C	128	3.3	2.7	TQFP	144	96	C
	LC4128V-5T144C	128	3.3	5	TQFP	144	96	C
	LC4128V-75T144C	128	3.3	7.5	TQFP	144	96	C
	LC4128V-27T128C	128	3.3	2.7	TQFP	128	92	C
	LC4128V-5T128C	128	3.3	5	TQFP	128	92	C
	LC4128V-75T128C	128	3.3	7.5	TQFP	128	92	C
	LC4128V-27T100C	128	3.3	2.7	TQFP	100	64	C
	LC4128V-5T100C	128	3.3	5	TQFP	100	64	C
	LC4128V-75T100C	128	3.3	7.5	TQFP	100	64	C
LC4256V	LC4256V-3FT256AC	256	3.3	3	ftBGA	256	128	C
	LC4256V-5FT256AC	256	3.3	5	ftBGA	256	128	C
	LC4256V-75FT256AC	256	3.3	7.5	ftBGA	256	128	C
	LC4256V-3FT256BC	256	3.3	3	ftBGA	256	160	C
	LC4256V-5FT256BC	256	3.3	5	ftBGA	256	160	C
	LC4256V-75FT256BC	256	3.3	7.5	ftBGA	256	160	C
	LC4256V-3F256AC <sup>1</sup>	256	3.3	3	fpBGA	256	128	C
	LC4256V-5F256AC <sup>1</sup>	256	3.3	5	fpBGA	256	128	C
	LC4256V-75F256AC <sup>1</sup>	256	3.3	7.5	fpBGA	256	128	C
	LC4256V-3F256BC <sup>1</sup>	256	3.3	3	fpBGA	256	160	C
	LC4256V-5F256BC <sup>1</sup>	256	3.3	5	fpBGA	256	160	C
	LC4256V-75F256BC <sup>1</sup>	256	3.3	7.5	fpBGA	256	160	C
	LC4256V-3T176C	256	3.3	3	TQFP	176	128	C
	LC4256V-5T176C	256	3.3	5	TQFP	176	128	C
	LC4256V-75T176C	256	3.3	7.5	TQFP	176	128	C
	LC4256V-3T144C	256	3.3	3	TQFP	144	96	C
	LC4256V-5T144C	256	3.3	5	TQFP	144	96	C
	LC4256V-75T144C	256	3.3	7.5	TQFP	144	96	C
	LC4256V-3T100C	256	3.3	3	TQFP	100	64	C
	LC4256V-5T100C	256	3.3	5	TQFP	100	64	C
LC4256V-75T100C	256	3.3	7.5	TQFP	100	64	C	
LC4384V	LC4384V-35FT256C	384	3.3	3.5	ftBGA	256	192	C
	LC4384V-5FT256C	384	3.3	5	ftBGA	256	192	C
	LC4384V-75FT256C	384	3.3	7.5	ftBGA	256	192	C
	LC4384V-35F256C <sup>1</sup>	384	3.3	3.5	fpBGA	256	192	C
	LC4384V-5F256C <sup>1</sup>	384	3.3	5	fpBGA	256	192	C
	LC4384V-75F256C <sup>1</sup>	384	3.3	7.5	fpBGA	256	192	C
	LC4384V-35T176C	384	3.3	3.5	TQFP	176	128	C
	LC4384V-5T176C	384	3.3	5	TQFP	176	128	C
	LC4384V-75T176C	384	3.3	7.5	TQFP	176	128	C

## ispMACH 4000V (3.3V) Lead-Free Industrial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4256V	LC4256V-5FTN256AI	256	3.3	5	Lead-free ftBGA	256	128	I
	LC4256V-75FTN256AI	256	3.3	7.5	Lead-free ftBGA	256	128	I
	LC4256V-10FTN256AI	256	3.3	10	Lead-free ftBGA	256	128	I
	LC4256V-5FTN256BI	256	3.3	5	Lead-free ftBGA	256	160	I
	LC4256V-75FTN256BI	256	3.3	7.5	Lead-free ftBGA	256	160	I
	LC4256V-10FTN256BI	256	3.3	10	Lead-free ftBGA	256	160	I
	LC4256V-5FN256AI <sup>1</sup>	256	3.3	5	Lead-free fpBGA	256	128	I
	LC4256V-75FN256AI <sup>1</sup>	256	3.3	7.5	Lead-free fpBGA	256	128	I
	LC4256V-10FN256AI <sup>1</sup>	256	3.3	10	Lead-free fpBGA	256	128	I
	LC4256V-5FN256BI <sup>1</sup>	256	3.3	5	Lead-free fpBGA	256	160	I
	LC4256V-75FN256BI <sup>1</sup>	256	3.3	7.5	Lead-free fpBGA	256	160	I
	LC4256V-10FN256BI <sup>1</sup>	256	3.3	10	Lead-free fpBGA	256	160	I
	LC4256V-5TN176I	256	3.3	5	Lead-free TQFP	176	128	I
	LC4256V-75TN176I	256	3.3	7.5	Lead-free TQFP	176	128	I
	LC4256V-10TN176I	256	3.3	10	Lead-free TQFP	176	128	I
	LC4256V-5TN144I	256	3.3	5	Lead-free TQFP	144	96	I
	LC4256V-75TN144I	256	3.3	7.5	Lead-free TQFP	144	96	I
	LC4256V-10TN144I	256	3.3	10	Lead-free TQFP	144	96	I
	LC4256V-5TN100I	256	3.3	5	Lead-free TQFP	100	64	I
	LC4256V-75TN100I	256	3.3	7.5	Lead-free TQFP	100	64	I
LC4256V-10TN100I	256	3.3	10	Lead-free TQFP	100	64	I	
LC4384V	LC4384V-5FTN256I	384	3.3	5	Lead-free ftBGA	256	192	I
	LC4384V-75FTN256I	384	3.3	7.5	Lead-free ftBGA	256	192	I
	LC4384V-10FTN256I	384	3.3	10	Lead-free ftBGA	256	192	I
	LC4384V-5FN256I <sup>1</sup>	384	3.3	5	Lead-free fpBGA	256	192	I
	LC4384V-75FN256I <sup>1</sup>	384	3.3	7.5	Lead-free fpBGA	256	192	I
	LC4384V-10FN256I <sup>1</sup>	384	3.3	10	Lead-free fpBGA	256	192	I
	LC4384V-5TN176I	384	3.3	5	Lead-free TQFP	176	128	I
	LC4384V-75TN176I	384	3.3	7.5	Lead-free TQFP	176	128	I
LC4384V-10TN176I	384	3.3	10	Lead-free TQFP	176	128	I	
LC4512V	LC4512V-5FTN256I	512	3.3	5	Lead-free ftBGA	256	208	I
	LC4512V-75FTN256I	512	3.3	7.5	Lead-free ftBGA	256	208	I
	LC4512V-10FTN256I	512	3.3	10	Lead-free ftBGA	256	208	I
	LC4512V-5FN256I <sup>1</sup>	512	3.3	5	Lead-free fpBGA	256	208	I
	LC4512V-75FN256I <sup>1</sup>	512	3.3	7.5	Lead-free fpBGA	256	208	I
	LC4512V-10FN256I <sup>1</sup>	512	3.3	10	Lead-free fpBGA	256	208	I
	LC4512V-5TN176I	512	3.3	5	Lead-free TQFP	176	128	I
	LC4512V-75TN176I	512	3.3	7.5	Lead-free TQFP	176	128	I
	LC4512V-10TN176I	512	3.3	10	Lead-free TQFP	176	128	I

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.